

UNDERGRADUATE ARCHITECTURE SCHOLARSHIP APPLICATION

RICHARD M. and SIDNEY K. ROBINSON SCHOLARSHIP

The Robinson Scholarship is intended for and limited to students at the <u>University of Michigan Taubman College of Architecture and Urban Planning</u> who are currently enrolled in the first year of the architecture program and intend to continue enrollment in the second year. The award is \$4,000 for 2023.

There are 6 parts to this application. Please fill in the form where indicated and attach exhibits at the end of the application form and submit in PDF format.

1. PERSONAL DATA

Name					
Last		First		Midd	е
Home Address					
Nun	nber & Street	City	State	Zip	
Telephone	E	mail Address			
County of Residence					
Social Security Number (last 4 digits only)Date or			th//	_ Marital Statu	IS
2. EMPLOYMENT HIS	TORY				
List below full-time, summer	r, or part-time er	mployment and exp	olain your duties a	nd responsibil	ities (beginning
with most recent).					
a. Employer/type of busines	ss			From	To
Position/Duties				Salary \$	
b. Employer/type of busines	SS			From	To

Position/Duties	Salary \$
3. SCHOLASTIC INFORMATION	
Name of University	Date of Enrollment//
Current year in school Anticipated Date of Graduation/_	_/ Current grade point average
4. CERTIFICATION I agree that the application and all attachments may be used for the Michigan Architectural Foundation. I also state that all information per processing the state of the	
knowledge.	
Signature	Date

5. ROBINSON SCHOLARSHIP - Submit, in PDF format, a 750-word one-page essay specifically communicating your understanding of the role of the architect as a Citizen/Artist. Your commitment to and understanding of the dual role of the architect in society is the primary focus of this award. **Please review the Introduction to the Robinson Scholarship on our website before submitting your essay.**

Also, submit, in PDF format, a no more than five (5) page portfolio of your studio work illustrating projects from the first semester of your first year in the architecture program at the University of Michigan.

6. COLLEGE TRANSCRIPTS - Please attach an 8-1/2 x 11 current copy of your college transcript.

DEADLINES

The <u>Undergraduate Architecture Scholarship</u> applications and materials are due via email by <u>MARCH. 1, 2023.</u>

Send completed applications and materials to:

Timothy A. Casai, FAIAE tcasai@tmp-architecture.com